MICROCHIP

MX555LBH27M0000

Ultra-Low Jitter 27MHz LVCMOS XO

ClockWorks® FUSION

General Description

The MX555LBH27M0000 is an ultra-low phase jitter XO with LVCMOS output optimized for high line rate applications.

Features

- 27MHz LVCMOS
- Typical phase noise:
 - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Absolute Maximum Ratings¹

| +4.6V |
|------------------------|
| 260°C |
| 115°C |
| 65°C to +125°C 200V |
| 200V |
| 2kV |
| |

Operating Ratings²

| Supply Voltage (VIN) | +2.375V to $+3.63$ V |
|----------------------------------|----------------------|
| Ambient Temperature (TA) | 40°C to $+85$ °C |
| Junction Thermal Resistance | |
| LGA (T _{IC}) Still Air | 58°C/W |
| ` JC ′ | |

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, output terminated with 50 Ohms to VDD/2.3

| Symbol | Parameter | Condition | Min. | Тур. | Max. | Units |
|--------|---------------------|--------------------------------------------------------------------------|-----------|------------|-----------|-------|
| IDD | Supply Current | | | | 95 | mA |
| F0 | Center Frequency | | | 27 | | MHz |
| | Frequency Stability | Note 4 | | | ±50 | ppm |
| Øj | Phase Noise | Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz) | | 220 100 | | fsRMS |
| Tstart | Start-Up Time | | | | 20 | ms |
| TR/TF | Rise/Fall time | | 100 | | 500 | ps |
| | Duty Cycle | | 45 | | 55 | % |
| VIH | Input High Voltage | 3.3V Operation | 2 | | VDD + 0.3 | V |
| VIL | Input Low Voltage | 3.3V Operation | -0.3 | | 0.8 | V |
| VOH | Output High Voltage | LVCMOS output levels | VDD - 0.8 | | | V |
| VOL | Output Low Voltage | LVCMOS output levels | | | 0.6 | V |

Notes

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- 3. Guaranteed after thermal equilibrium.
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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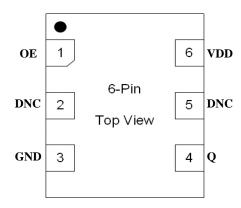
October 22, 2020 MX555LB1-9394 Revision 1.0 tcghelp@microchip.com

Ordering Information

| Ordering Part Number | Marking Line 1 | Marking Line 3 | Shipping | Package |
|-----------------------------|----------------|----------------|---------------|-----------------------|
| MX555LBH27M0000 | MX555L | BH0270 | Tube | 6-Pin 5mm x 3.2mm LGA |
| MX555LBH27M0000-TR | MX555L | BH0270 | Tape and Reel | 6-Pin 5mm x 3.2mm LGA |

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



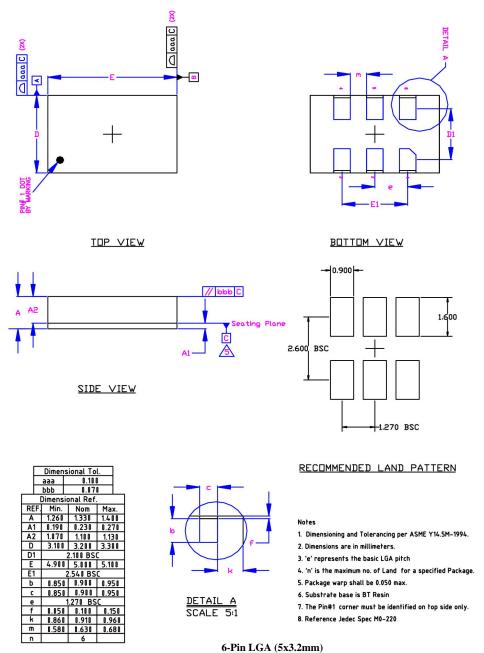
Pin Description

| Pin Number | Pin Name | Pin Type | Pin Level | Pin Function | |
|------------|----------|----------|----------------------------------------------------------------------------------------------------------|-------------------------------------|--|
| 1 | OE | I, SE | LVCMOS Output Enable, disables output to tri-state, 1 = Disabled, 0 = Enabled, 50k Ohms Pull-Down (Int | | |
| 2 | DNC | | | Make no connection, leave floating. | |
| 3 | GND | PWR | | Power Supply Ground | |
| 4, 5 | Q, DNC | O, SE | LVCMOS | Clock Output Frequency = 27MHz | |
| 6 | VDD | PWR | | Power Supply | |

Environmental Specifications

| Thermal Shock | MIL-STD-883, Method 1011, Condition A | |
|------------------------------|-------------------------------------------------------------|--|
| Moisture Resistance | MIL-STD-883, Method 1004 | |
| Mechanical Shock | MIL-STD-883, Method 2002, Condition C | |
| Mechanical Vibration | MIL-STD-883, Method 2007, Condition A | |
| Resistance to Soldering Heat | J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max) | |
| Hazardous Substance | Pb-Free / RoHS / Green Compliant | |
| Solderability | JESD22-B102-D Method 2 (Preconditioning E) | |
| Terminal Strength | MIL-STD-883, Method 2004, Test Condition D | |
| Gross Leak | MIL-STD-883, Method 1014, Condition C | |
| Fine Leak | MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s | |
| MSL Level | Crystal - MSL-1, Package MSL-3 | |
| Solvent Resistance | MIL-STD-202, Method 215 | |

Package Information and Recommended Land Pattern for 6-Pin LGA³



Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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